



# P-Channel 20 V (D-S) MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	$R_{DS(on)}$ ( $\Omega$ ) Max.	I <sub>D</sub> (A)	Q <sub>g</sub> (Typ.)		
- 20	0.078 at V <sub>GS</sub> = - 4.5 V	- 1.4			
	0.098 at V <sub>GS</sub> = - 2.5 V	- 1	12.1 nC		
	0.130 at V <sub>GS</sub> = - 1.8 V	- 1	12.1110		
	0.188 at V <sub>GS</sub> = - 1.5 V	- 0.3			

#### **FEATURES**

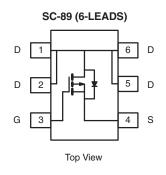
- TrenchFET® Power MOSFET
- Typical ESD Performance 2500 V
- 100 % R<sub>g</sub> Tested
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

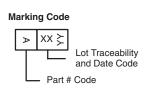


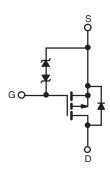
HALOGEN **FREE** 

#### **APPLICATIONS**

- Load Switch for Portable Devices
- Power Management







Ordering Information: Si1077X-T1-GE3 (Lead (Pb)-free and Halogen-free)

P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25 °C, unless otherwise noted)						
Parameter		Symbol	Limit	Unit		
Drain-Source Voltage		V <sub>DS</sub>	- 20	V		
Gate-Source Voltage		V <sub>GS</sub>	± 8	v		
Continuous Drain Current (T <sub>.I</sub> = 150 °C)	T <sub>A</sub> = 25 °C	1-	- 1.75 <sup>b, c</sup>			
Continuous Diam Current (1) = 150 °C)	T <sub>A</sub> = 70 °C	I <sub>D</sub>	- 1.4 <sup>b, c</sup>			
Pulsed Drain Current (t = 300 μs)		I <sub>DM</sub>	- 8	A		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	°C I <sub>S</sub> - 0.28 <sup>b, c</sup>				
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	0.33 <sup>b, c</sup>	w		
Maximum Fower Dissipation	T <sub>A</sub> = 70 °C	'D	0.21 <sup>b, c</sup>			
Operating Junction and Storage Temperature R	ange	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Marrian In a Air A Anabian A	t ≤ 5 s	R <sub>thJA</sub>	300	375	°C/W	
Maximum Junction-to-Ambient <sup>a, b</sup>	Steady State		360	450	C/VV	

- a. Maximum under steady state conditions is 450  $^{\circ}\text{C/W}.$
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 5 s.

# Vishay Siliconix



<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C, unless otherwise noted)							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V, I}_{D} = -250 \mu\text{A}$	- 20			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = - 250 μA		- 11		m\//°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = - 250 μA		2.4		mV/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = -250 \mu A$	- 0.4		- 1	V	
	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 10		
Gate-Source Leakage		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 4.5 \text{ V}$			± 1		
Zava Cata Valtaga Dvain Current	I <sub>DSS</sub>	V <sub>DS</sub> = - 20 V, V <sub>GS</sub> = 0 V			- 1	– μA –	
Zero Gate Voltage Drain Current		$V_{DS}$ = - 20 V, $V_{GS}$ = 0 V, $T_{J}$ = 85 °C			- 10		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} = \ge -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	- 8			Α	
		V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 1.8 A		0.065	0.078		
	D	V <sub>GS</sub> = - 2.5 V, I <sub>D</sub> = - 1 A		0.081	0.098	Ω	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 1.8 V, I <sub>D</sub> = - 1 A		0.100	0.130		
		V <sub>GS</sub> = - 1.5 V, I <sub>D</sub> = - 0.3 A		0.125	0.188		
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = - 10 V, I <sub>D</sub> = - 1.8 A		10		S	
Dynamic <sup>b</sup>							
Input Capacitance	C <sub>iss</sub>			965		pF	
Output Capacitance	C <sub>oss</sub>	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		110			
Reverse Transfer Capacitance	C <sub>rss</sub>			101			
Total Cata Chaves	Qg	V <sub>DS</sub> = - 10 V, V <sub>GS</sub> = - 8 V, I <sub>D</sub> = - 1.75 A		20.7	31.1		
Total Gate Charge		$Q_{gs}$ $V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -1.75 \text{ A}$		12.1	18.2	nC	
Gate-Source Charge	Q <sub>gs</sub>			1.85			
Gate-Drain Charge	$Q_{gd}$			2.21			
Gate Resistance	$R_g$	f = 1 MHz	3.6	18	36	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			24	36		
Rise Time	t <sub>r</sub>	$V_{DD} = -10 \text{ V}, R_{L} = 7.1 \Omega$		17	26	ns	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong -1.4 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_g = 1 \Omega$		95	145		
Fall Time	t <sub>f</sub>			28	42	1	
Turn-On Delay Time	t <sub>d(on)</sub>			5	10		
Rise Time	t <sub>r</sub>	$V_{DD} = -10 \text{ V}, R_L = 7.1 \Omega$		8	16	ns	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D = -1.4 \text{ A}, V_{GEN} = -8 \text{ V}, R_g = 1 \Omega$		115	173		
Fall Time	t <sub>f</sub>			26	39	]	
Drain-Source Body Diode Characteristics							
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				- 8	Α	
Body Diode Voltage	$V_{SD}$	I <sub>S</sub> = - 1.4 A		- 0.75	- 1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			16	24	ns	
Body Diode Reverse Recovery Charge Q <sub>rr</sub>		l <sub>F</sub> = - 1.4 A, dl/dt = 100 A/μs		7	14	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	1 - 171, αι/αι - 100 //μο		9			
Reverse Recovery Rise Time t				7		ns	

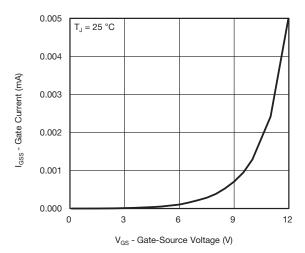
#### Notes:

- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

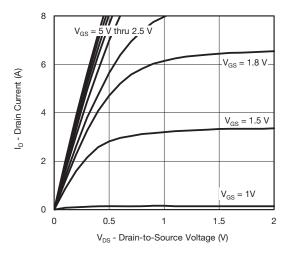
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



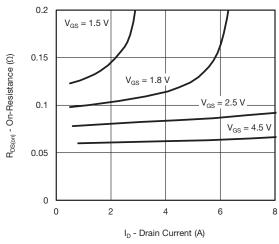
#### **TYPICAL CHARACTERISTICS** ( $T_A = 25$ °C, unless otherwise noted)



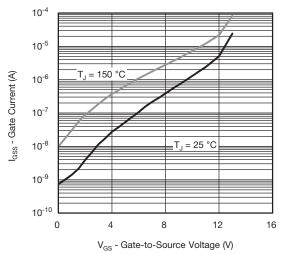
#### Gate Current vs. Gate-Source Voltage



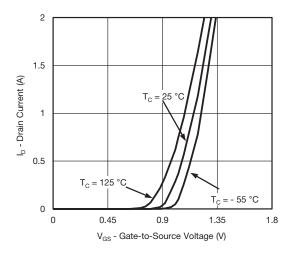
#### **Output Characteristics**



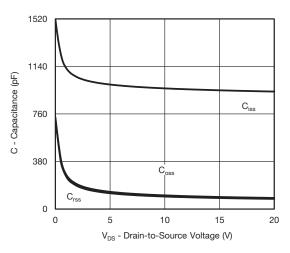
On-Resistance vs. Drain Current



Gate Current vs. Gate-to-Source Voltage



Transfer Characteristics Curves vs. Temperature

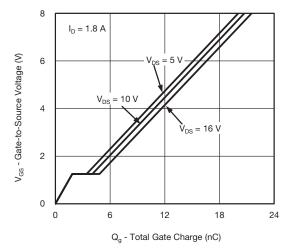


Capacitance

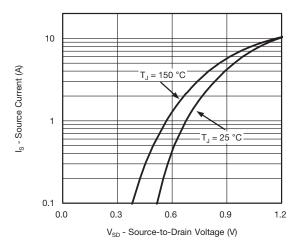
## Vishay Siliconix

# VISHAY

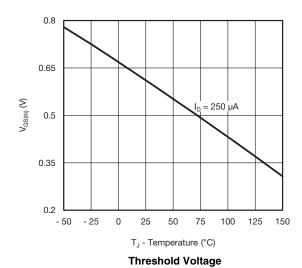
#### **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)

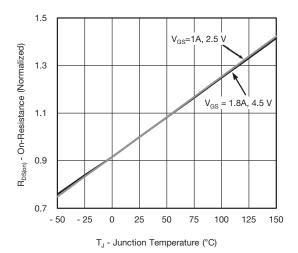


#### **Gate Charge**

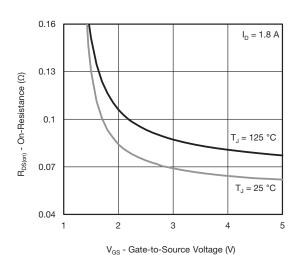


#### Source-Drain Diode Forward Voltage

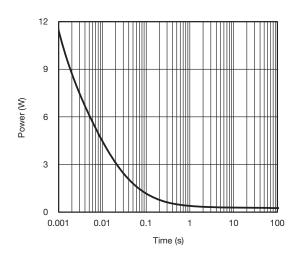




On-Resistance vs. Junction Temperature



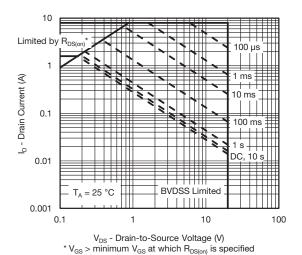
On-Resistance vs. Gate-to-Source Voltage

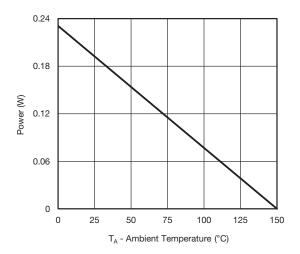


Single Pulse Power, Junction-to-Ambient



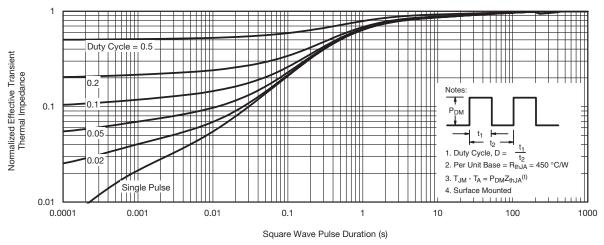
#### **TYPICAL CHARACTERISTICS** ( $T_A = 25$ °C, unless otherwise noted)





Safe Operating Area, Junction-to-Ambient

**Power Junction-to-Ambient** 

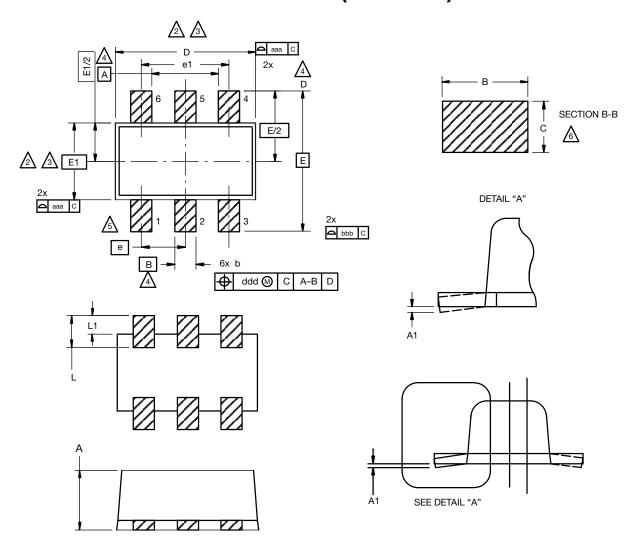


Normalized Thermal Transient Impedance, Junction-to-Ambient

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?63254.



# **SC-89 6-Leads (SOT-563F)**



#### Notes

1. Dimensions in millimeters.

Dimension D does not include mold flash, protrusions or gate burrs. Mold flush, protrusions or gate burrs shall not exceed 0.15 mm per dimension E1 does not include interlead flash or protrusion, interlead flash or protrusion shall not exceed 0.15 mm per side.

Dimensions D and E1 are determined at the outmost extremes of the plastic body exclusive of mold flash, the bar burrs, gate burrs and interlead flash, but including any mismatch between the top and the bottom of the plastic body.

ADatums A, B and D to be determined 0.10 mm from the lead tip.

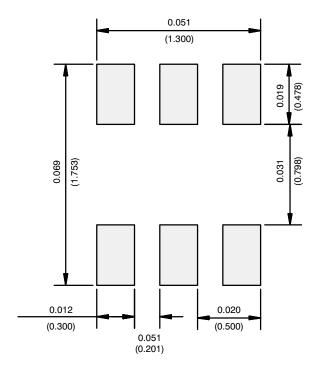
A Terminal numbers are shown for reference only.

These dimensions apply to the flat section of the lead between 0.08 mm and 0.15 mm from the lead tip.

DIM.	MILLIMETERS					
	MIN.	NOM.	MAX.			
Α	0.56	0.58	0.60			
A1	0	0.02	0.10			
b	0.15	0.22	0.30			
С	0.10	0.14	0.18			
D	1.50	1.60	1.70			
E	1.50	1.60	1.70			
E1	1.15	1.20	1.25			
е	0.45	0.50	0.55			
e1	0.95	1.00	1.05			
L	0.25	0.35	0.50			
L1	0.10	0.20	0.30			
C14-0439-Rev. C, 11-Aug-14 DWG: 5880						



#### **RECOMMENDED MINIMUM PADS FOR SC-89: 6-Lead**



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index

APPLICATION NOTE



### **Legal Disclaimer Notice**

Vishay

#### **Disclaimer**

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

# **Mouser Electronics**

**Authorized Distributor** 

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Vishay: SI1077X-T1-GE3